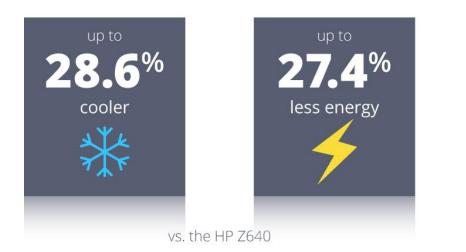
WORKSTATION HEAT AND POWER USAGE: LENOVO THINKSTATION P700 VS. HP Z640 WORKSTATION

Run cooler. Use less energy.

The Lenovo® ThinkStation® P700





Workstations vary considerably in the amount of heat they generate and in the amount of power they consume. A system with a cooler operating temperature helps you in two ways: its components are less likely to fail, and it necessitates less air conditioning to keep the office at a comfortable temperature. A more power-efficient system can lower your electric bill by using less electricity and running cooler.

At Principled Technologies, we tested the Lenovo ThinkStation P700 and the HP Z640 Workstation. We found that the Lenovo workstation was less power-hungry than the HP workstation and ran cooler while idle and under load. These findings show that the Lenovo ThinkStation P700 could contribute to a reliable user experience and a more comfortable office environment while saving on electricity costs.



WHICH WORKSTATION DELIVERS RELIABILITY, POWER-EFFICIENCY, AND A PLEASANT WORK ENVIRONMENT?

A workstation that generates more heat and uses more power than necessary can be more prone to system failure, can be distracting and uncomfortable for workers, and can boost electricity bills—both because of the power the system itself draws and the power that additional air conditioning uses. To determine how two workstations compared on these fronts, we measured the heat and power consumption of the Lenovo ThinkStation P700 and the HP Z640 Workstation.

We performed the tests while the two systems were idle and again while they were running a heavy workload that consisted of two benchmarks stressing each system's hard disk, processor, and memory.

	Lenovo ThinkStation P700	HP Z640	Lenovo ThinkStation P700 was		
Heat (degrees Celsius above room temperature)					
Idle					
Average rear system exhaust fan	4.61°	6.95°	33.7% cooler		
Average of six surface locations	2.0°	2.8°	28.6% cooler		
Under load					
Average rear system exhaust fan	21.45°	21.91°	2.1% cooler		
Average of six surface locations	6.2°	7.1°	12.7% cooler		
Power usage (watts)					
Average while idle	72.0	99.2	Used 27.4% less power		
Average under load	281.7	293.7	Used 4.1% less power		

Figure 1 presents highlights of our test results.

Figure 1: Test results summary. Lower numbers are better.

For detailed specifications of our test systems, see <u>Appendix A</u>. For details of our testing, see <u>Appendix B</u>.

COOL UNDER PRESSURE

The operating temperatures of computers vary considerably. While one advantage of a cooler workstation is obvious—no one wants a hot office—workstations running at cooler temperatures also bring other benefits.

Excess heat can cause hard drives, CPUs, memory, and other components to fail. For example, overheating can expand hard drive platters, causing hard drive failure. At the very least, excess heat can reduce the drive's effective operating life. According to a recent Fujitsu white paper, hard disk manufacturers now suggest cooler operating temperatures for drive enclosures.¹ Because many users fail to back up their data on a regular basis, adequate ventilation and cooling in a workstation can help significantly to avoid problems such as catastrophic data loss due to hard drive failure.

Many workers are not fortunate enough to have control over the climate in their offices. Not only do workstations with higher operating temperatures place extra wear on hardware, but they can make an already warm office even more uncomfortable.

With system reliability and user comfort in mind, we measured the temperature of several external spots on the two workstations while they were idle and while they were running a heavy workload. Given that most workstations run 24 hours a day, we believe the most appropriate measure of thermal performance is the temperature of the air exiting the rear exhaust when the workstation is idle.

For each of the locations, we measured the temperature three times and noted the number of degrees Celsius each measurement deviated from the ambient room temperature. Because the ambient temperature varied throughout our testing, the temperature difference between the ambient temperature and the surface temperature we recorded for each system makes the fairest comparison. As Figure 2 shows, the Lenovo ThinkStation P700 ran cooler idle and while under load.

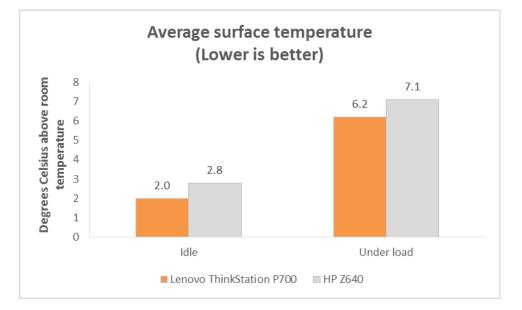


Figure 2: When idle and under load, the Lenovo ThinkStation P700 ran cooler than the HP workstation.

¹ <u>www.fujitsu.com/downloads/COMP/fcpa/hdd/sata-mobile-ext-duty_wp.pdf</u>

Workstation heat and power usage: Lenovo ThinkStation P700 vs. HP Z640 Workstation

LESS POWER USED IS BETTER

A workstation that uses less power can save you money when the electric bill comes. As Figure 3 shows, when the two systems were idle, the Lenovo ThinkStation P700 used up to 27.4 percent less power than the HP workstation. We used an Extech® Power Analyzer to measure power consumption.

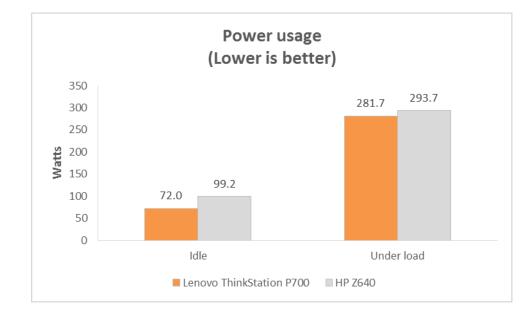


Figure 3: When idle, the Lenovo ThinkStation P700 used up to 27.4 percent less power than the HP workstation.

IN CONCLUSION

A workstation that runs coolly and uses less power is a great asset to workers and the companies they work for. In our tests, both when idle and when under load, the Lenovo ThinkStation P700 generally ran at lower surface temperatures and used less power than the HP Z640 Workstation. These findings show that the Lenovo ThinkStation P700 could meet the needs of those who want to provide a reliable, comfortable work environment while using less power.

APPENDIX A: DETAILED SYSTEM CONFIGURATION

Figure 4 presents detailed configuration information for the two systems we tested.

System	Lenovo ThinkStation P700	HP Z640 Workstation
General	1	
Number of processor packages	2	2
Number of cores per processor	10	10
Number of hardware threads per	2	2
core	2	Z
Total number of processor threads in	40	40
system		
System power management policy	ThinkCentre [®] Default	Balanced
	Enhanced Intel [®] SpeedStep [®]	Enhanced Intel SpeedStep
Processor power-saving option	Technology	Technology
СРО		
Vendor	Intel	Intel
Name	Xeon®	Xeon
Model number	E5-2650V3	E5-2650V3
Stepping	MO	MO
Socket type	Socket 2011 LGA	Socket 2011 LGA
Core frequency (GHz)	2.3 GHz – 3.0 GHz (Turbo)	2.3 GHz – 3.0 GHz (Turbo)
L1 cache	10 × 32 KB + 10 × 32 KB	10 × 32 KB + 10 × 32 KB
L2 cache	10 × 256 KB	10 × 256 KB
L3 cache	25 MB	25 MB
Platform	1	1
Vendor	Lenovo	Hewlett-Packard
Motherboard model number	N/A	212A
Motherboard chipset	Intel C600	Intel C600
BIOS name and version	Lenovo A5KT73AUS (06/04/2015)	Hewlett-Packard M60 v01.58 (06/09/2015)
Memory module(s)		
Vendor and model number	Hyundai Electronics	Sameung® M20241C40DP0 CDD
vendor and model number	HMA41GR7MFR4N-TF	Samsung [®] M393A1G40DB0-CPB
Туре	DDR4-2133	DDR4-2133
Speed (MHz)	2,133	2,133
Speed running in the system (MHz)	2,133	2,133
Timing/Latency (CL-tRCD-tRP-tRAS- tRFC)	31-31-31-63-1023	31-31-31-63-1023
Size (MB)	8,192	8,192
Number of memory module(s)	8	8
Total amount of system RAM (GB)	64	64
Channel (Single/Dual/Quad)	Quad	Quad

System	Lenovo ThinkStation P700	HP Z640 Workstation
Hard disk	I	1
Vendor and model number	Western Digital [®] WD5000AAKX-0	Toshiba DT01ACA0
Number of disks in system	2	2
Size (GB)	500	500
Buffer size (MB)	16	32
RPM	7,200	7,200
Туре	SATA 6.0 Gb/s	SATA 6.0 Gb/s
Controller	Intel C600+/C220+ series chipset SATA RAID Controller	Intel C600+/C220+ series chipset SATA RAID Controller
Driver	Intel 4.2.0.1136 (02/12/2015)	Intel 4.2.0.1136 (02/12/2015)
Operating system		
Name	Windows [®] 7 Professional	Windows 7 Professional
Build number	7601	7601
Service Pack	1	1
File system	NTFS	NTFS
Kernel	ACPI x64-based PC	ACPI x64-based PC
Language	English	English
Microsoft [®] DirectX [®] version	11	11
Graphics	-	
Vendor and model number	NVIDIA [®] Quadro [®] K620	NVIDIA Quadro K620
Туре	Discrete	Discrete
Chipset	Quadro K620	Quadro K620
BIOS version	82.7.7a.0.3	82.7.7a.0.13
Total available graphics memory (MB)	5,839	34,513
Dedicated video memory (MB)	2,048	2,048
System video memory (MB)	0	0
Shared system memory (MB)	3,791	32,465
Resolution	1,280 × 1,024	1,280 × 1,024
Driver	NVIDIA 9.18.13.4803 (04/13/2015)	NVIDIA 9.18.13.4752 (02/05/2015)
Sound card/subsystem		
Vendor and model number	Realtek High Definition Audio	Realtek High Definition Audio
Driver	Realtek 6.0.1.7240 (05/06/2014)	Realtek 6.0.1.7427 (01/13/2015)
Ethernet		· · · · · · · · · · · ·
Vendor and model number	Intel Ethernet Connection (2) I218-LM	Intel Ethernet Connection (2) I218-LM
Driver	Intel 12.12.80.19 (09/29/2014)	Intel 12.12.50.4 (06/12/2014)
Optical drive(s)	· · · · · · · · · · · · · · · · · · ·	· · · · · · · · ·
Vendor and model number	LG GHCON	HP DU8A6SH
Туре	DVD-RW	DVD-RW

System	Lenovo ThinkStation P700	HP Z640 Workstation			
USB ports					
Number	12	10			
Туре	8 × USB 3.0, 4 × USB 2.0	8 × USB 3.0, 2 × USB 2.0			
Other	Media Card Reader	Media Card Reader			
Monitor					
Model	ViewSonic [®] VG730m	ViewSonic VG730m			
LCD type	SXGA LCD	SXGA LCD			
Screen size	17″	17″			
Refresh rate	60 Hz	60 Hz			
Maximum Resolution	1,280 × 1,024	1,280 × 1,024			

Figure 4: Detailed configuration information for the test systems.

APPENDIX B: DETAILED TEST METHODOLOGY

Measuring surface temperature

Test requirements

- Fluke[®] 2680A Data Acquisition System
- PassMark[®] BurnInTest[™] Professional
- LINPACK benchmark

Measuring system temperature and power while idle

Setting up the test

- 1. Set the power plan to the manufacturer's default setting. Set the display brightness to 100 percent:
 - a. Click Start.
 - b. In the Start menu's quick search field, type Power Options
 - c. Move the Screen brightness slider all the way to the right.
- 2. Set the remaining power plan settings as follows:
 - Dim the display: Never
 - Turn off the display: Never
 - Put the computer to sleep: Never
- 3. Disable the screen saver.
- 4. Place the workstation, mouse, keyboard, and display in a windowless, climate-controlled room.
- 5. Attach a Type T thermocouple to the exterior of the workstation at the following locations:
 - Front (Centered in front of Intake fan if there is one, otherwise centered of case)
 - Rear Exhaust fan (Centered)
 - PSU Exhaust fan (Centered)
 - Top (Centered)
 - Side closest to the motherboard (Centered)
 - Side opposite to the motherboard (Centered)
- 6. Configure the Fluke 2680A Data Acquisition System to take measurements from the temperature probes and one ambient temperature probe using the Fluke DAQ software:
 - a. Connect the Type T thermocouples to channels in the Fluke Fast Analog Input module (FAI).
 - b. In the Fluke DAQ software, click each surface temperature channel, select Thermocouple from the list of Functions, and choose T from the list of ranges.
 - c. Label each channel with the location associated with each thermocouple.
 - d. In the Fluke DAQ software, click the ambient temperature channel, select Thermocouple from the list of Functions, and choose T from the list of ranges.
 - e. Label this channel Ambient.
- 7. While running each test, use a Fluke 2680A Data Acquisition System to monitor ambient temperature and temperature at each interior and exterior point.
- 8. Connect the power cord from the workstation to the Extech Instruments 380803 Power Analyzer's DC output load power outlet.
- 9. Plug the power cord from the Power Analyzer's DC input voltage connection into a power outlet.
- 10. Connect a separate host computer to the Power Analyzer using an RS-232 cable. This computer will monitor and collect the power measurement data.
- 11. Turn on the Extech Power Analyzer by pressing the green On/Off button.
- 12. Turn on the host computer.

- 13. Insert the Extech software installation CD into the host computer, and install the software.
- 14. Once installed, launch the Extech Power Analyzer software, and configure the correct COM port.

Running the test

- 1. Open Task Manager.
- 2. Bring up an elevated command prompt:
 - Select Windows Start orb.
 - Type cmd and press Control-Shift-Enter.
- 3. Type Cmd.exe /c start /wait Rundll32.exe advapi32.dll, ProcessIdleTasks
- 4. Do not interact with the system until the command completes.
- 5. Watch Task Manager and wait for disk activity to end before running the test.
- 6. Start the Fluke 2680A data logger using the Fluke DAQ software, and begin recording power with the Extech Power Analyzer.
- 7. Allow the workstation to sit idle for 1 hour.
- 8. After 1 hour, stop the Fluke 2680A data logger using the Fluke DAQ software, and stop the Power Analyzer data logger.
- 9. Export the thermal measurements to a CSV file. The Power Analyzer creates a CSV file as it collects that data.
- 10. Use the thermal measurement CSV file to find and report the average temperature measured at each location during the test.
- 11. Use the Power Analyzer CSV to calculate the average power draw in watts during the test.
- 12. Power the workstation off for 1 hour, and allow it to return to room temperature.
- 13. Repeat steps 1 through 9 two more times.

Measuring system temperature and power while under load

Setting up the test

- 1. Download PassMark BurnInTest Professional 7.0 from <u>www.passmark.com/products/bit.htm</u>.
- 2. Double-click bitpro_x64.exe to run setup.
- 3. At the Welcome screen, click Next.
- 4. Accept the license agreement, and click Next.
- 5. At the Choose Install Location screen, accept the default location of C:\Program Files\BurnInTest, and click Next.
- 6. At the Select Start Menu Folder screen, click Next.
- 7. At the Ready to Install screen, click Install.
- 8. At the Completing the BurnInTest Setup Wizard screen, deselect View Readme.txt, and click Finish to launch BurnInTest.
- 9. At the Purchasing information screen, copy and paste the Username and key, and click Continue.
- 10. At the Key accepted screen, click OK.
- 11. Select Test selection and duty cycles from the Configuration menu item.
- 12. Set Auto Stop to 120 minutes.
- 13. Select CPU, 2D Graphics, 3D Graphics, RAM, and Disk(s), and deselect all other subsystems.
- 14. Set load to 100 for each of the above selected subsystems, and click OK.
- 15. Select Test Preferences from the Configuration menu item and set or verify the following by clicking on each tab:
 - Disk: select C: drive
 - Logging: select Turn automatic logging on
 - 2D Graphics: select All available Video Memory

- 3D Graphics: use defaults
- CPU: use defaults
- 16. Unpack the LINPACK benchmark and adjust the number of instances, problem size, and leading dimension size so that the CPU is at 100% utilization, and the memory is as close to 100% utilization as possible. For example, for a system that has 8 threads:
 - a. Open the Instance1 directory.
 - b. Edit the runme_xeon64 batch file.
 - c. Set the OMP_NUM_THREADS= 8 (this number depends on how many threads the system has)
 - d. Delete the two echo lines, and save the batch file.
 - e. Repeat steps a-e for each LINPACK Instance that needs to be run. (This is done by trial and error on each system until CPU and RAM utilization is as close to 100% as possible.)
 - f. Once it is determined how many instances are needed, you are ready to start the test.

Running the test

- 1. Boot the system and launch PassMark BurnInTest by double-clicking the desktop icon.
- 2. Open Task Manager.
- 3. Bring up an elevated command prompt:
 - a. Select Windows Start orb.
 - b. Type cmd and press Control-Shift-Enter.
- 4. Type Cmd.exe /c start /wait Rundll32.exe advapi32.dll, ProcessIdleTasks Do not interact with the system until the command completes.
- 5. Watch Task Manager and wait for disk activity to end before running the test.
- 6. Click Start Selected Tests in the BurnInTest V7.0 Pro screen, and double-click the LINPACK benchmark batch file.
- 7. Once RAM levels have reached the desired level, close to 100%, start the Fluke 2680A data logger using the Fluke DAQ software, and begin recording power with the Extech Power Analyzer.
- 8. After 1 hour, stop the Fluke 2680A data logger using the Fluke DAQ software, and the Power Analyzer data logger.
- 9. Export the thermal measurements to a CSV file. The Power Analyzer creates a CSV file as it collects that data.
- 10. Use the thermal measurement CSV file to find and report the highest temperature measured at each location during the test.
- 11. Use the Power Analyzer CSV to calculate the average power draw in watts during the test.
- 12. Power the workstation off for 1 hour, and allow it to return to room temperature.
- 13. Repeat the steps 1 through 12 two more times.

Measuring power consumption

To record each workstation's power consumption during each test, we used an Extech Instruments (<u>www.extech.com</u>) 380803 Power Analyzer/Datalogger. We connected the power cord from the server under test to the Power Analyzer's output load power outlet. We then plugged the power cord from the Power Analyzer's input voltage connection into a power outlet.

We used the Power Analyzer's Data Acquisition Software (version 2.11) to capture all recordings. We installed the software on a separate Intel processor-based PC, which we connected to the Power Analyzer via an RS-232 cable. We captured power consumption at one-second intervals. We then recorded the power usage (in watts) for each system during the testing at one-second intervals. To compute the average power usage, we averaged the power usage during the time the system was producing its peak performance results.

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